IGBT - Field Stop, Trench 650 V, 75 A

FGH75T65UPD-F085

Description

Using Novel Field Stop Trench IGBT Technology, ON Semiconductor's new series of Field Stop Trench IGBTs offer the optimum performance for Automotive chargers, Solar Inverter, UPS and Digital Power Generator where low conduction and switching losses are essential.

Features

- Maximum Junction Temperature : $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} = 1.65 V (Typ.) @ I_C = 75 A
- High Input Impedance
- Tightened Parameter Distribution
- AEC-Q101Qualified and PPAP Capable
- This Device is Pb-Free and is RoHS Compliant

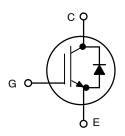
Applications

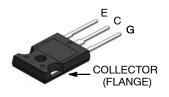
- Automotive Chargers, Converters, High Voltage Auxiliaries
- Solar Inverters, UPS, Digital Power Generator



ON Semiconductor®

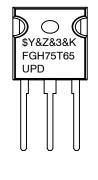
www.onsemi.com





TO-247-3LD CASE 340CK

MARKING DIAGRAM



\$Y	= ON Semiconductor Logo
&Z	= Assembly Plant Code
&3	= Numeric Date Code
&K	= Lot Code
FGH75T65UPD	= Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Description	Symbol	Ratings	Unit V		
Collector to Emitter Voltage	V _{CES}	650			
Gate to Emitter Voltage		V _{GES}	±20	V	
Collector Current	Tc = 25°C	Ι _C	150	Α	
	Tc = 100°C		75	Α	
Pulsed Collector Current	I _{CM} (Note 1)	225	Α		
Diode Forward Current	Tc = 25°C	١ _F	75	Α	
	Tc = 100°C		50	Α	
Pulsed Diode Maximum Forward Current		I _{FM} (Note 1)	225	Α	
Maximum Power Dissipation	Tc = 25°C	PD	375	W	
	Tc = 100°C		187	W	
Short Circuit Withstand Time	Tc = 25°C	SCWT	5	μs	
Operating Junction Temperature	TJ	-55 to +175	°C		
Storage Temperature Range	T _{stg}	–55 to +175	°C		
Maximum Lead Temperature for Soldering, 1/8" from C	TL	300	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Parameter	Symbol	Ratings	Unit
Thermal Resistance, Junction-to-Case	R _{0JC} (IGBT) (Note 2)	0.4	°C/W
Thermal Resistance, Junction-to-Case	R _{θJC} (Diode)	0.86	°C/W
Parameter	Symbol	Тур	
Thermal Resistance, Junction-to-Ambient (PCB Mount) (Note 2)	R _{0JA}	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Package Method	Reel Size	Tape Width	Quantity
FGH75T65UPD-F085	FGH75T65UPD	TO-247	Tube	-	-	30

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS		-				
Collector to Emitter Breakdown Voltage	BV _{CES}	V _{GE} = 0 V, I _C = 1 mA	650	-	-	V
Temperature Coefficient of Breakdown Voltage	$\Delta {\rm BV}_{\rm CES}/ \Delta {\rm T}_{\rm J}$	V_{GE} = 0 V, I _C = 1 mA	-	0.65	_	V/°C
Collector Cut-Off Current	I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
		I _{CES} at 80% * B _{VCES} , 175°C	-	-	3600	
G-E Leakage Current	I _{GES}	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
ON CHARACTERISTICs						
G-E Threshold Voltage	V _{GE(th)}	I_C = 75 mA, V_{CE} = V_{GE}	4.0	6.0	7.5	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C = 75 A, V _{GE} = 15 V	-	1.69	2.3	V
		I_{C} = 75 A, V_{GE} = 15 V, T_{C} = 175°C	-	2.21	-	V

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted) (continued)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
DYNAMIC CHARACTERISTICS		-		•		•
Input Capacitance	C _{ies}	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	5665	-	pF
Output Capacitance	C _{oes}		-	205	-	pF
Reverse Transfer Capacitance	C _{res}		-	100	-	pF
SWITCHING CHARACTERISTICS						-
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, I_C = 75 \text{ A},$	-	32	48	ns
Rise Time	t _r	$R_G = 3 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	-	43	71	ns
Turn-Off Delay Time	t _{d(off)}		-	166	216	ns
Fall Time	t _f		-	24	33	ns
Turn-On Switching Loss	E _{on}	-	_	2.85	4.80	mJ
Turn-Off Switching Loss	E _{off}		_	1.20	1.60	mJ
Total Switching Loss	E _{ts}		-	4.05	5.30	mJ
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, I_C = 75 \text{ A},$ $R_G = 3 \Omega, V_{GE} = 15 \text{ V},$ Inductive Load, $T_C = 175^{\circ}\text{C}$	_	30	-	ns
Rise Time	t _r		-	57	-	ns
Turn-Off Delay Time	t _{d(off)}		-	176	-	ns
Fall Time	t _f		-	21	-	ns
Turn-On Switching Loss	E _{on}		-	4.45	-	mJ
Turn–Off Switching Loss	E _{off}		-	1.60	-	mJ
Total Switching Loss	E _{ts}	1	-	6.05	-	mJ
Short Circuit Withstand Time	Tsc	V_{GE} = 15 V, V_{CC} \leq 400V, R_{G} = 10 Ω	5	-	-	μs
Total Gate Charge	Qg	V_{CE} = 400 V, I_{C} = 75 A, V_{GE} = 15 V	-	385	578	nC
Gate to Emitter Charge	Q _{ge}		-	45	68	nC
Gate to Collector Charge	Q _{gc}	1	_	210	315	nC

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_J = 25° C unless otherwise noted)

Parametr	Symbol	Test Conditions		Min	Тур	Max	Unit
Diode Forward Voltage	V _{FM}	I _F = 50 A	T _C = 25°C	-	2.1	2.6	V
			T _C = 175°C	-	1.7	-	
Reverse Recovery Energy	E _{rec}	$I_F = 50 \text{ A}, \text{ dI}_F/\text{dt} = 200 \text{ A}/\mu\text{s}$	T _C = 175°C	-	40	-	μJ
Diode Reverse Recovery Time	t _{rr}		T _C = 25°C	-	43	85	ns
			T _C = 175°C	-	162	-	
Diode Reverse Recovery Charge	Q _{rr}		T _C = 25°C	-	83	170	nC
			T _C = 175°C	-	805	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
2. R0jc for TO-247: according to Mil standard 883-1012 test method. R0ja for TO-247: according to JESD51-2, test method environmental

 R0jc for TO-247 : according to Mil standard 883-1012 test method. R0ja for TO-247 : according to JESD51-2, test method environmental condition and JESD51-10, test boards for through hole perimeter leaded package thermal measurements. JESD51-3 : Low Effective Thermal Conductivity Test Board for Leaded Surface Mount Package.

TYPICAL PERFORMANCE CHARACTERISTICS

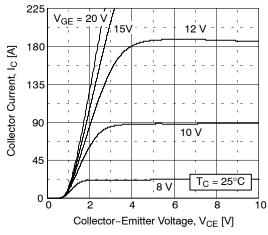


Figure 1. Typical Output Characteristics

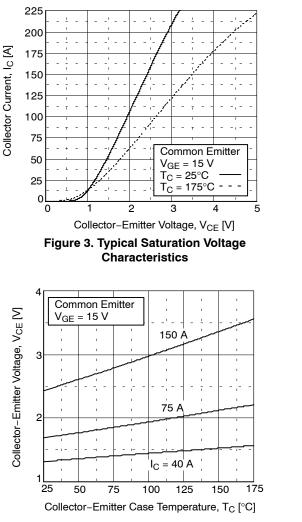


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

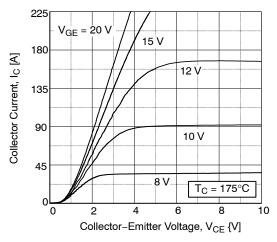
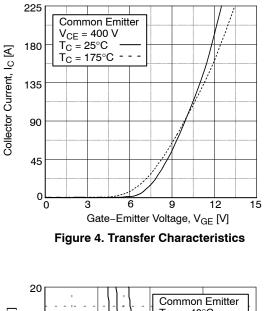


Figure 2. Typical Output Characteristics



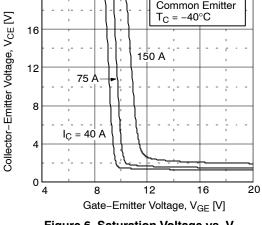
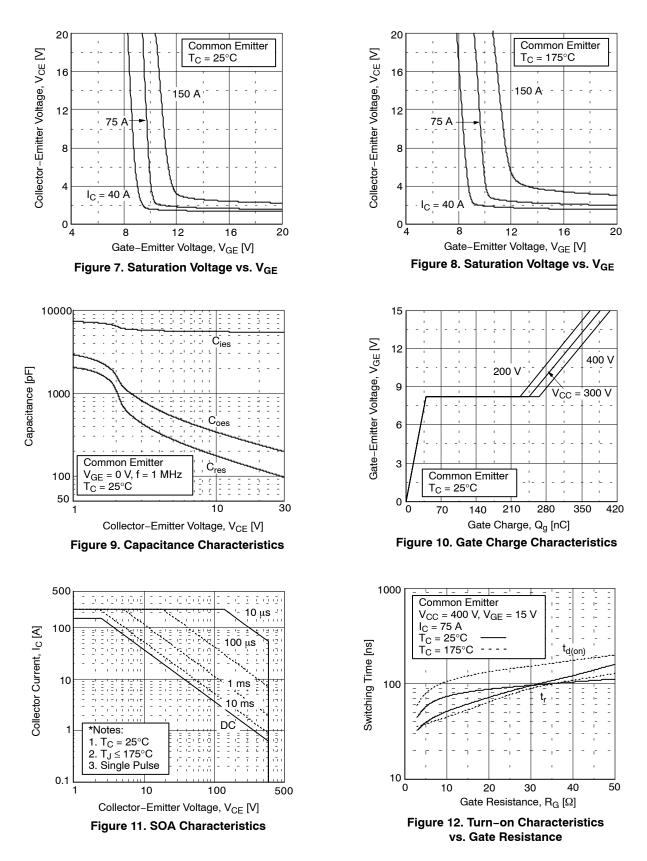
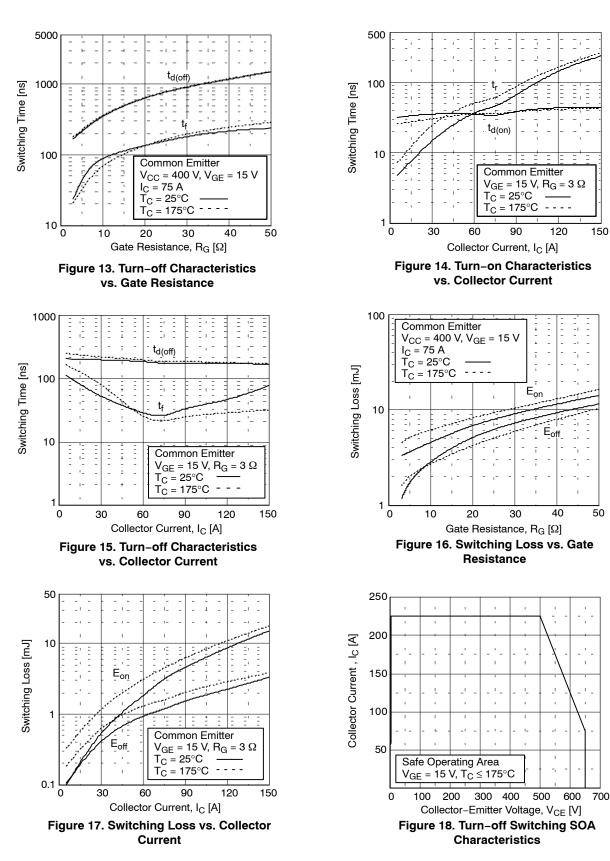
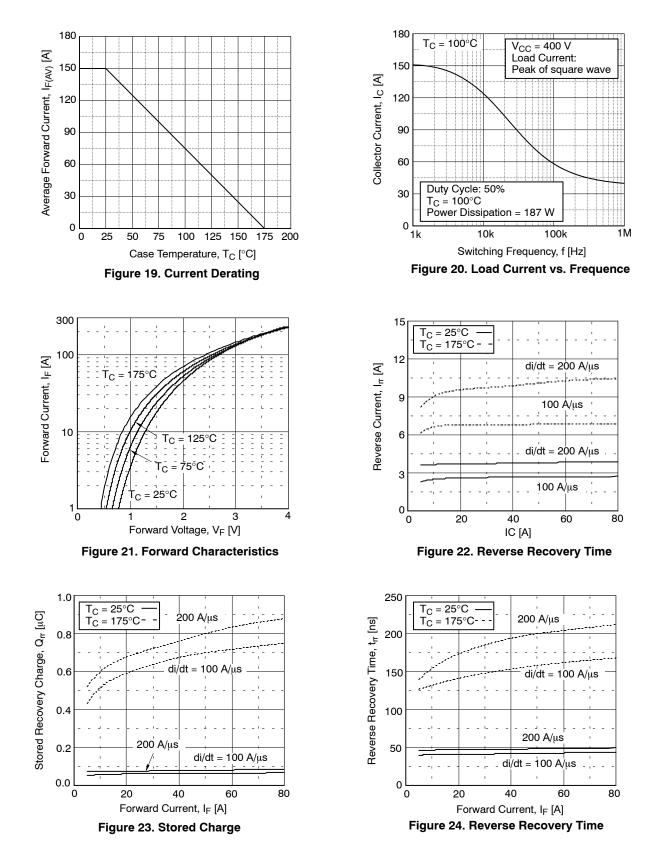


Figure 6. Saturation Voltage vs. $V_{\mbox{\scriptsize GE}}$







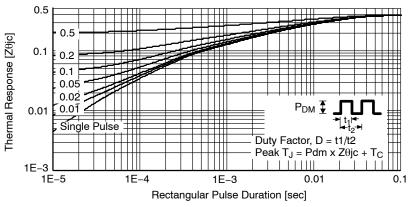


Figure 25. Transient Thermal Impedance of IGBT

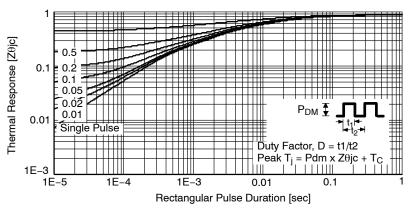


Figure 26. Transient Thermal Impedance of Diode





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